

APPROVAL SHEET

MULTILAYER CERAMIC CAPACITORS

Low Profile Series

0402 to 1210 Sizes

X7R, X5R & Y5V Dielectrics

Halogen Free & RoHS Compliance



^{*}Contents in this sheet are subject to change without prior notice.

1. DESCRIPTION

MLCC consists of a conducting material and electrodes. To manufacture a chip-type SMT and achieve miniaturization, high density and high efficiency, ceramic condensers are used.

WTC TT series MLCC is used in product having thickness concerned generally have high capacitance and thinner product thickness. The high dielectric constant material X7R, X5R and Y5V are used for this series product.

2. FEATURES

- a. Standard size with thin thickness.
- b. Small size with high capacitance.
- c. Capacitor with lead-free termination (pure Tin).

3. APPLICATIONS

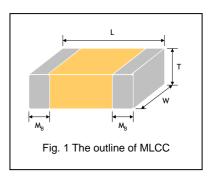
- a. For LCD panels.
- b. For PCMCA cards.
- c. For IC packaging and modules.
- d. Any thickness concerned products.

4. HOW TO ORDER

<u>TT</u>	<u>15</u>	<u>X</u>	<u>475</u>	<u>M</u>	<u>6R3</u>	<u>C</u>	Ī
<u>Series</u>	Size	Dielectric	Capacitance	Tolerance	Rated voltage	Termination	<u>Packaging</u>
		/	Z NE LE N	1/4			
TT=Low profile	15 =0402 (1005)	B =X7R	Two significant	K =±10%	Two significant	C =Cu/Ni/Sn	T=7" reeled
	18 =0603 (1608)	X =X5R/ ///	digits followed by	M=±20%	digits followed by		G=13" reeled
	21 =0805 (2012)	F=Y5V 777/4	no. of zeros. And	Z =-20/+80%	no. of zeros. And		
	31 =1206 (3216)		R is in place of		R is in place of		
	32 =1210 (3225)		decimal point.	54	decimal point.		
			PASSIVE SYS	TEM ALLIANCE			
			eg.:		6R3 =6.3 VDC		
		COPVIRIGH	475=47x10 ⁵		100 =10 VDC		
		195	=4,700,000pF		160 =16 VDC		
		C	=4.7µF	100	250 =25 VDC		
		1	1/c Chno	CO/	500 =50 VDC		
			JEQU.	UBY TON	101 =100 VDC		

5. EXTERNAL DIMENSIONS

Size Inch (mm)	L (mm)	W (mm)	T (mm)/Sy	mbol	M _B (mm)
0402 (1005)	1.00±0.2	0.5±0.2	0.30±0.03	L	0.25±0.10
0603 (1608)	1.6+0.15/-0.10	0.8+0.15/-0.10	0.50±0.10	Н	0.40±0.15
0805 (2012)	2.00±0.20	1.25±0.20	0.85±0.10	Т	0.50±0.20
4000 (0040)	2 20 - 0 20	4.00.000	0.85±0.10	Т	0.00.000
1206 (3216)	3.20±0.20	1.60±0.20	1.15±0.15	J	0.60±0.20
1210 (2225)	2 20 . 0 20	2.50.0.20	0.85±0.10	Т	0.75 . 0.25
1210 (3225)	3.20±0.30	2.50±0.20	2.00±0.20	K	0.75±0.25



6. GENERAL ELECTRICAL DATA

Dielectric	X7R	X5R	Y5V				
Size		0402, 0603, 0805, 1206, 1210					
Capacitance range*	1μF to 10μF	0.22μF to 22μF	1μF to 10μF				
Capacitance tolerance**	K (±10%	K (±10%), M (±20%)					
Rated voltage (WVDC)	10V, 16V, 25V, 50V, 100V	6.3V, 10V, 16V, 25V	10V, 16V, 25V, 50V				
Operating temperature	-55 to +125℃	-55 to +85℃	-25 to +85℃				
Capacitance characteristic	±15% +30/-80%						
Termination	Ni/Sn (lead-free termination)						

^{*} Measured at 1.0±0.2Vrms, 1.0kHz±10%, 30~70% related humidity, 25°C ambient temperature for X7R, X5R and at 20°C for Y5V.

^{*} Reflow soldering process only is recommended.

^{**} Preconditioning for Class II MLCC: Perform a heat treatment at 150±10°C for 1 hour, then leave in a mbient condition for 24±2 hours before measurement.

Multilayer Ceramic Capacitors

7. CAPACITANCE RANGE

7-1 X7R dielectric

	Dielectric	X7R										
	Size		80	05		1206			1210			
Rate	ed voltage (VDC)	10	16	25	50	10	16	25	50	10	16	100
	1.0µF (105)							Т				
a)	1.5µF (155)											
Capacitance	2.2µF (225)		Т	Т					Т			K
ita	3.3µF (335)											
ac	4.7μF (475)	Т						Т				
Sag	6.8µF (685)											
	10μF (106)					Т						
	22μF (226)											

7-2 X5R dielectric

	Dielectric									K5R								
	Size	0402		06	03		0805		1206				1210					
Rate	ed voltage (VDC)	6.3	10	25	10	16	6.3	10	16	25	6.3	10	16	25	50	10	16	25
	0.22uF (224)			L	Н	Н												
	0.47uF (474)	L		L														
	1.0µF (105)	L			Н	Н		Т	Т	Т		Т	Т	Т				
e	1.5µF (155)							T	T			Т	Т	Т				
au	2.2µF (225)	L					7 -	LT.	T	J		Т	Т	Т	Т			
Ċ	3.3µF (335)					146	775	=	7	7		Т	Т	Т		Т		
Capacitance	4.7μF (475)	L			H	K K	T	пT	T	1		Т	Т	Т		Т		
ပိ	6.8µF (685)				IX		坛	阪1	万态	- , '5	2							
	10μF (106)				140	P. 4	$\times \tau$	Т	T	150	(0,<	J/T		Т		Т		Т
	22uF (226)				144177	-XXX	Т	Т		<f' -<="" th=""><th></th><th>7/</th><th>Т</th><th></th><th></th><th></th><th>Т</th><th></th></f'>		7/	Т				Т	
	47uF (476)				17	·					T							

7-3 Y5V dielectric

	Dielectric		Y5V								
	Size		0805			1206				1210	
Rate	ed voltage (VDC)	10	16	25	50	10	16	25	50	10	16
	1.0µF (105)		1	0) T		(O)	\$2/			
4	1.5µF (155)			4/11.	19ch		0110	3			
35	2.2µF (225)		Т	75/1		OIOEA,	T	T	Т		
itaı	3.3µF (335)	Т			(ECHAIDIO	OL CORROLL	TIMI.				
Capacitance	4.7μF (475)	Т	Т		LINDIO	JY EUKYUN	T				
ğ	6.8µF (685)					T					
	10μF (106)	Т				Т				Т	
	22μF (226)										

8. PACKAGING STYLE AND QUANTITY

Cina	This large May (1999)	VC. mala al	7" reel				
Size	Thickness Max (mm)/Symbol		Paper tape	Plastic tape			
0402 (1005)	0.33	L	15k	-			
0603 (1608)	0.60	Н	4k	-			
0805 (2012)	0.95	Т	4k	-			
4000 (0040)	0.95	Т	4k	-			
1206 (3216)	1.30	J	-	3k			
4040 (200E)	0.95	Т	-	3k			
1210 (3225)	2.00	K	-	1k			

Unit: pieces



Approval Sheet

9. RELIABILITY TEST CONDITIONS AND REQUIREMENTS

No.	Item	Test Condition	Requirements				
1.	Visual and		* No remarkable defect.				
	Mechanical		* Dimensions to conform to individual specification sheet.				
_	Capacitance	Cap≤10µF, 1.0±0.2Vrms, 1kHz±10%	* Shall not exceed the limits given in the detailed spec.				
	-	Cap>10μF, 0.5±0.2Vrms, 120Hz±20%**	X7R/X5R:				
ა.	Q/ D.F.	** Test condition: 0.5±0.2Vrms , 1KHz±10%	Rated vol. D.F.				
	(Dissipation	TT18X≧475(10V) , TT15X series	100V ≤5%				
	Factor)	*Before initial measurement (Class II only): To apply de-aging	50V, 25V, 16V, 10V ≤10% 6.3V ≤15%				
		at 150°C for 1hr then set for 24±2 hrs at room temp.	Y5V:				
			Rated vol. D.F.				
			50V ≤7%				
			25V ≤9%				
			16V/10V ≤12.5%				
4.	Dielectric	* To apply voltage: 250% rated voltage. * Duration: 1 to 5 sec.	* No evidence of damage or flash over during test.				
	Strength	* Charge and discharge current less than 50mA.					
5.	Insulation	* To apply rated voltage for max. 120 sec.	i≥10GΩ or RxC≥100Ω-F whichever is smaller.				
J.		* Before initial measurement (Class II only): To apply de-aging	21000 of txo21000-1 whichever is sitialier.				
	Resistance	at 150℃ for 1hr then set for 24±2 hrs at room temp.					
6.	Temperature	With no electrical load.					
	Coefficient	T.C. Operating Temp X7R -55~125℃ at 25℃	T.C. Capacitance Change				
		X5R -55~85°C at 25°C	X7R Within ±15%				
		Y5V -25~85℃ at 20℃	X5R Within ±15%				
		*Before initial measurement (Class II only):	Y5V Within +30%/-80%				
		To apply de-aging at 150℃ for 1hr then set for 24± 2 hrs at					
		room temp.					
		01005 0201 Cap≤0.01µF: 0.5V Cap<0.1µF:1V					
		Cap≤0.01μF: 0.5V Cap<0.1μF:1V	(1)				
		Cap≥1μF: 0.1V					
		0402 0603 Cap<1μF: 1V Cap≤1μF: 1V					
		Cap=1μF: 0.5V 1μF <cap≤4.7μf: 0.5v<="" th=""> 1μF<cap<4.7μf: 0.2v<="" td=""> Cap>4.7μF: 0.2V</cap<4.7μf:></cap≤4.7μf:>					
		Cap≥10µF: 0.1V PASSIVE SYSTEM ALI	IANCE				
		0805 1206/1210					
		Cap<10μF: 1V					
		Cap>10μF: 0.2V	10 8				
7.	Adhesive	* Pressurizing force : 5N (≤0603) and 10N (>0603)	* No remarkable damage or removal of the terminations.				
	Strength of	* Test time: 10±1 sec.	To formation durings of formoval of the terminations.				
	_	Yearongy					
_	Termination	* Vibration frequency: 10~55 Hz/min.					
8.	Vibration	* Total amplitude: 1.5mm	* No remarkable damage.				
	Resistance	* Test time: 6 hrs. (Two hrs each in three mutually	* Cap change and Q/D.F.: To meet initial spec.				
		perpendicular directions.)					
		* Before initial measurement (Class II only):					
		To apply de-aging at 150℃ for 1hr then set for 24±2 hrs at					
		room temp. * Cap./DF(Q) Measurement to be made after de-aging at					
		150°C for 1hr then set for 24±2 hrs at room temp.					
9.	Solderability	* Solder temperature: 235±5℃	95% min. coverage of all metalized area.				
		* Dipping time: 2±0.5 sec.					
10.	Bending Test	* The middle part of substrate shall be pressurized by means	* No remarkable damage.				
		of the pressurizing rod at a rate of about 1 mm per second until	* Cap change :				
		the deflection becomes 1 mm and then the pressure shall be maintained for 5±1 sec.	X7R/X5R: within ±12.5%				
		* Before initial measurement (Class II only):					
		To apply de-aging at 150℃ for 1hr then set for 24± 2 hrs at	Y5V: within ±30% (This capacitance change means the change of capacitance under				
		room temp.	specified flexure of substrate from the capacitance measured before				
		* Measurement to be made after keeping at room temp. for	the test.)				
		24±2 hrs.					
11.	Resistance to	* Solder temperature: 260±5°C * Dipping time: 10±1 sec	* No remarkable damage.				
	Soldering Heat	* Preheating: 120 to 150°C for 1 minute before immerse the	* Can abanga:				
		capacitor in a eutectic solder.	e X7R/X5R: within ±7.5%				
		*Before initial measurement (Class II only): To apply de-aging	Y5V: within ±20%				
		at 150℃ for 1hr then set for 24±2 hrs at room temp.	* O/D F I B and dialoctric atronath; To most initial requirements				
		*Cap. / DF(Q) / I.R. Measurement to be made after de-aging at					
		150℃ for 1hr then set for 24±2 hrs at room temp.	25% max. leaching on each edge.				

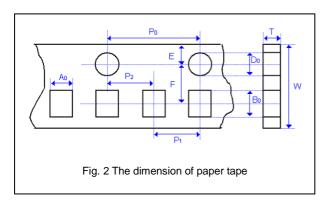
Multilayer Ceramic Capacitors

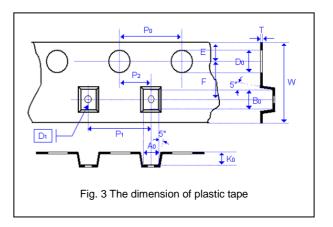


No.	Item	Test Condition		Requirements
12.	Temperature	* Conduct the five cycles according to the tem	peratures and	* No remarkable damage.
	Cycle	time.		* Cap change :
		Step Temp. (℃)	Time (min.)	X7R/X5R: within ±7.5%
		1 Min. operating temp. +0/-3	30±3	Y5V: within ±20%
		2 Room temp. 2	2~3	* Q/D.F., I.R. and dielectric strength: To meet initial requirements.
		3 Max. operating temp. +3/-0	30±3	
		4 Room temp. 2	2~3	
		* Before initial measurement (Class II only): To	,	
		at 150℃ for 1hr then set for 24±2 hrs at room	•	
		* Cap. / DF(Q) / I.R. Measurement to be made		
		at 150℃ for 1hr then set for 24±2 hrs at room	temp.	*No remarkable demons
13.	Humidity	* Test temp.: 40±2℃		*No remarkable damage. *Cap change: X7R/X5R: within ±25%
	(Damp Heat)	* Humidity: 90~95% RH		Y5V: within ±30%; 6.3V, within +30/-40%
	Steady State	* Test time: 500+24/-0hrs.		*Q/D.F. value:
		* Before initial measurement (Class II only): To	apply de-aging	
		at 150℃ for 1hr then set for 24±2 hrs at room	temp.	Rated vol. D.F.
		* Cap. / DF(Q) / I.R. Measurement to be made	after de-aging	100V ≤7.5% 25V. 16V ≤15%
		at 150℃ for 1hr then set for 24±2 hrs at room	temp.	
				10V ≤20% 50V, 6.3V ≤30%
				Y5V:
		EK	有 1	Rated vol. D.F.
		LALE PL		50V ≤10%
		Y. NE	比阳份:	25V ≤15%
			9 DX 1/1 2	16V, 10V ≤20%
		Hym L		*I.R.: 1GΩ or RxC≩10 Ω-F whichever is smaller.
1/	Humidity	* Toot town : 40 : 290		*No remarkable damage.
14.		* Test temp.: 40±2°C		*Cap change: X7R/X5R: within ±25%
	(Damp Heat)	* Humidity: 90~95%RH	$\supset \subseteq \angle$	Y5V: within ±30%; 6.3V, within +30/-40%
	Load	* Test time: 500+24/-0 hrs.	E SYSTEM AL	*Q/D.F. value:
		* To apply voltage: Rated voltage.		X7R/X5R:
		* Before initial measurement (Class II only): To at 150°C for 1hr then set for 24±2 hrs at room		Rated vol. D.F.
		* Cap. / DF(Q) / I.R. Measurement to be made		100V ≤7.5%
				25V, 16V ≤15%
			temp.	10V ≤20%
		at 150℃ for 1hr then set for 24±2 hrs at room	Wology '	[50V, 6.3V ≤30%
		I CHNI	Mary coppos	Y5V:
			LUUI LUNTUI	Rated vol. D.F.
				50V ≤10%
				25V ≤15% 16V, 10V ≤20%
15	I I : b	* Test temp. :		*I.R.: 500MΩ or RxC≧5 Ω-F whichever is smaller.
13.	High	NP0, X7R/X7E: 125±3℃		*No remarkable damage. **Cap change: X7R/X5R: within ±25%
	Temperature 	X5R, Y5V: 85±3℃		Y5V: within ±30%; 6.3V, within ±30/-40%
	Load	* Test time: 1000+24/-0 hrs.		*Q/D.F. value:
	(Endurance)	* To apply voltage: 150% of rated voltage. **100% of rated voltage for below range.		X7R/X5R:
		Pated Car	pacitance	Rated vol. D.F.
		Size Dielectric voltage	range	100V ≤7.5%
			≥1.0µF	25V, 16V ≤15%
		V5\/ 6.3\/ C	<u>≥2.2μF</u> ≥10μF	10V ≤20%
		X5R/X7R/X6S ≤10V C	≥10µF	50V, 6.3V ≤30%
		TT31 Y5V 6.3V C	≧22μF	Y5V:
		*Before initial measurement (Class II only): To	apply de-aging	Rated vol. D.F.
		at 150°C for 1hr then set for 24±2 hrs at room	,	50V ≤10%
		* Cap. / DF(Q) / I.R. Measurement to ©r de-ag	•	25V ≤15%
		1hr then set for 24±2 hrs at room temp.		16V, 10V ≤20%
				*I.R.: 1GΩ or RxC≧10 Ω-F whichever is smaller.
		•		

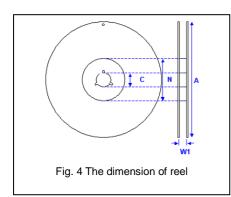
APPENDIXES

■ Tape & reel dimensions





Size	0402	0603	0805	12	06	12	10
Thickness	L	Н	Т	Т	J	Т	K
A ₀	0.70 +/-0.2	1.05 +/-0.30	1.50 +/-0.20	1.90 +/-0.50	< 2.00	< 3.05	< 3.05
B ₀	1.20 +/-0.2	1.80 +/-0.30	2.30 +/-0.20	3.50 +/-0.50	< 3.70	< 3.80	< 3.80
Т	≦0.80	≦1.20	≦1.30	≦1.30	0.23 +/-0.1	0.23 +/-0.1	0.23 +/-0.1
K ₀	-	- ##/17	MAX -		< 2.50	< 1.50	< 2.50
w	8.00 +/-0.10	8.00 +/-0.10	8.00 +/-0.10	8.00 +/-0.10	8.00 +/-0.20	8.00 +/-0.20	8.00 +/-0.20
P ₀	4.00 +/-0.10	4.00 +/-0.10	4.00 +/-0.10	4.00 +/-0.10	4.00 +/-0.10	4.00 +/-0.10	4.00 +/-0.10
10xP₀	40.00 +/-0.10	40.00 +/-0.20	40.00 +/-0.20	40.00 +/-0.20	40.00 +/-0.20	40.00 +/-0.20	40.00 +/-0.20
P ₁	2.00 +/-0.05	4.00 +/-0.10	4.00 +/-0.10	4.00 +/-0.10	4.00 +/-0.10	4.00 +/-0.10	4.00 +/-0.10
P ₂	2.00 +/-0.05	2.00 +/-0.05	2.00 +/-0.05	2.00 +/-0.05	2.00 +/-0.05	2.00 +/-0.05	2.00 +/-0.05
D ₀	1.55 +/-0.05	1.55 +/-0.05	1.55	1.55 +/-0.05	1.50 +0.1/-0	1.50 +0.1/-0	1.50 +0.1/-0
D ₁	-	-	SANOLOGY COR	bokkling.	1.00 +/-0.10	1.00 +/-0.10	1.00 +/-0.10
E	1.75 +/-0.05	1.75 +/-0.05	1.75 +/-0.05	1.75 +/-0.05	1.75 +/-0.10	1.75 +/-0.10	1.75 +/-0.10
F	3.50 +/-0.05	3.50 +/-0.05	3.50 +/-0.05	3.50 +/-0.05	3.50 +/-0.05	3.50 +/-0.05	3.50 +/-0.05

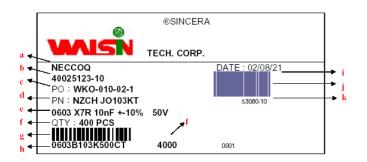


Size	0402, 0603, 0805, 1206, 1210							
Reel size	7"	10"	13"					
С	13.0+0.5/-0.2	13.0+0.5/-0.2	13.0+0.5/-0.2					
\mathbf{W}_1	8.4+1.5/-0	8.4+1.5/-0	8.4+1.5/-0					
Α	A 178.0±1.0		330.0±1.0					
N	N 60.0+1.0/-0		100±1.0					



Approval Shee

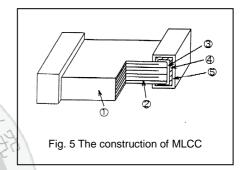
Description of customer label



- a. Customer name
- b. WTC order series and item number
- c. Customer P/O
- d. Customer P/N
- e. Description of product
- f. Quantity
- g. Bar code including quantity & WTC P/N or customer
- h. WTC P/N
- i. Shipping date
- j. Order bar code including series and item numbers
- k. Serial number of label

Constructions

No.	Nam	ne	X7R, X5R, Y5V			
1	Ceramic r	material	BaTiO₃ based			
2	Inner ele	ctrode	Ni.			
3		Inner layer	Cu			
4	Termination	Middle layer	以 Nix lix lix lix lix lix lix lix lix lix l			
(5)		Outer layer	Sn (Matt)			





Storage and handling conditions

- (1) To store products at 5 to 40°C ambient temperature and 20 to 70%, related humidity conditions.
- (2) The product is recommended to be used within one year after shipment. Check solderability in case of shelf life extension is needed.

Cautions:

- a. The corrosive gas reacts on the terminal electrodes of capacitors, and results in the poor solderability. Do not store the capacitors in the ambience of corrosive gas (e.g., hydrogen sulfide, sulfur dioxide, chlorine, ammonia gas etc.)
- b. In corrosive atmosphere, solderability might be degraded, and silver migration might occur to cause low reliability.
- c. Due to the dewing by rapid humidity change, or the photochemical change of the terminal electrode by direct sunlight, the solderability and electrical performance may deteriorate. Do not store capacitors under direct sunlight or dewing condition. To store products on the shelf and avoid exposure to moisture.

■ Recommended soldering conditions

The lead-free termination MLCCs are not only to be used on SMT against lead-free solder paste, but also suitable against lead-containing solder paste. If the optimized solder joint is requested, increasing soldering time, temperature and concentration of N_2 within oven are recommended.

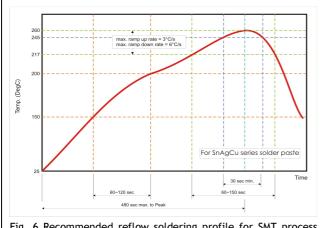


Fig. 6 Recommended reflow soldering profile for SMT process with ${\sf SnAgCu}$ series solder paste.

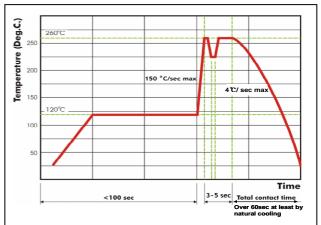


Fig. 7 Recommended wave soldering profile for SMT process with SnAgCu series solder.

